



HIGH SPEED PRINTING, NO CLEAN, PIN TESTABLE



Multicore MP100 solder cream has been formulated as a pale soft residue product for printing and reflow in air, where process yield is critical. With an enhanced tack and shelf life, it is highly recommended for most applications.



- ◆ Suitable for fine pitch high speed stencil printing up to at least 150mm s⁻¹
- ◆ Excellent printer open time and tack life
- ◆ Excellent slump resistance
- ◆ Resists solder balling
- ◆ Longer shelf life
- ◆ Preferred, all purpose solder paste
- ◆ 500g tubs

MP100 Solder Paste

Packaged in 500g plastic jars with an insert to seal off the surface of the cream. Meets IPC-SF-818 and Bellcore TR-NWT-000078 without cleaning.

500g TUBS

Manf. Part No. & Anglia Order Code
SN62MP100AGS90

A 62% tin, 36% lead, 2% silver alloy as 90%, total mass content. Solder powder particle size 20 to 45µm.

MP100 should be stored within 24 hours of receipt at 5-10°C, tightly sealed in its original container, to maximise shelf life.



Also available to special order

- Other Solder Pastes
- Other packaging options
 - Syringes for small quantity
 - Cartridges for all machine types



SCREEN/STENCIL AND REWORK CLEANER

Multicore Prozone SC-01 removes solder paste residues from screens and stencils and can also be used for cleaning reworked circuit assemblies.



- ◆ Removes all types of residues from screens, stencils, equipment and PCB's
- ◆ No ozone depleting chemicals and chlorine free
- ◆ Handy 500ml trigger spray pack

Prozone® Solvent Cleaner

Packaged in 500ml trigger spray packs.

500ml SPRAY PACKS

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SC-01

Further Multicore products available

list overleaf > > > >

